RClamp0521PA Ultra-Low Capacitance 1-Line ESD protection

PROTECTION PRODUCTS - RailClamp®

Description

RailClamp® TVS arrays are ultra low capacitance ESD protection devices designed to protect high speed data interfaces. This series has been specifically designed to protect sensitive components which are connected to high-speed data and transmission lines from overvoltage caused by ESD (electrostatic discharge), CDE (Cable Discharge Events), and EFT (electrical fast transients).

The RClamp®0521PA has a maximum capacitance of only 0.50pF. This allows it to be used on circuits operating in excess of 3GHz without signal attenuation. They may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge).

The RClamp0521PA is in a 2-pin SLP1006P2 package measuring $1.0 \times 0.6 \times 0.5$ mm. The leads are spaced at a pitch of 0.65mm and feature a lead-free finish. Each device will protect one high-speed line operating at 5 volts. It gives the designer the flexibility to protect single lines in applications where arrays are not practical. The combination of small size, low capacitance, and high ESD surge capability makes them ideal for use in applications such as cellular phones and digital video interfaces.

Features

- ◆ Transient protection for data lines to IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact) IEC 61000-4-4 (EFT) 40A (tp = 5/50ns) Cable Discharge Event (CDE)
- ◆ Ultra-small package (1.0 x 0.6 x 0.5mm)
- ◆ Protects one data or I/O line
- ◆ Low capacitance: **0.5pF**
- Low clamping voltage
- Low operating voltage: 5.0V
- Solid-state silicon-avalanche technology

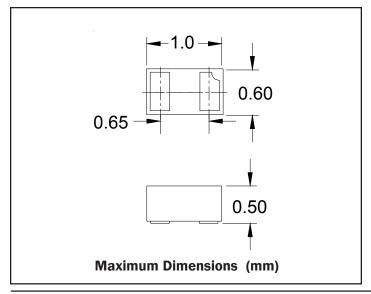
Mechanical Characteristics

- SLP1006P2 package
- Molding compound flammability rating: UL 94V-0
- Marking: Marking code
- Packaging: Tape and Reel
- Lead Finish: NiPdAu
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant

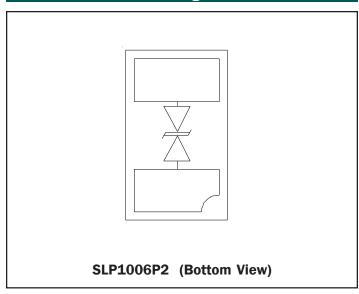
Applications

- Cellular Handsets & Accessories
- Digital Visual Interface (DVI)
- Display Port
- MDDI Ports
- USB Ports
- PCI Express
- Serial ATA

Dimensions



Schematic & PIN Configuration





Absolute Maximum Rating

Rating	Symbol	Value	Units	
Peak Pulse Power (tp = 8/20µs)	P _{pk}	100	Watts	
Peak Pulse Current (tp = 8/20μs)	I _{PP}	4	А	
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	+/- 15 +/- 8	kV	
Operating Temperature	T,	-55 to +125	°C	
Storage Temperature	T _{STG}	-55 to +150	°C	

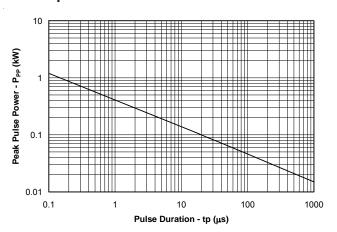
Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V _{RWM}				5	V
Reverse Breakdown Voltage	V _{BR}	I _t = 1mA	6	9.3	11	V
Reverse Leakage Current	I _R	V _{RWM} = 5V, T=25°C		0.025	1	μΑ
Clamping Voltage	V _c	I _{PP} = 1A, tp = 8/20μs			15	V
Clamping Voltage	V _c	$I_{pp} = 4A$, tp = 8/20µs			25	V
Junction Capacitance	C _j	V _R = OV, f = 1MHz		0.30	0.50	pF

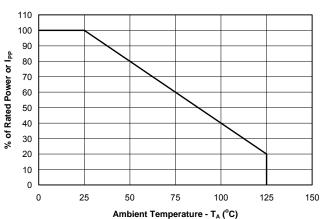


Typical Characteristics

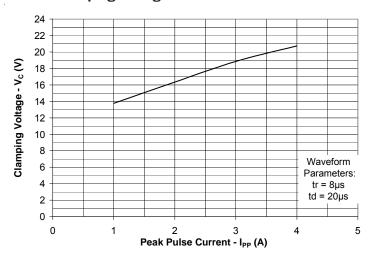
Non-Repetitive Peak Pulse Power vs. Pulse Time



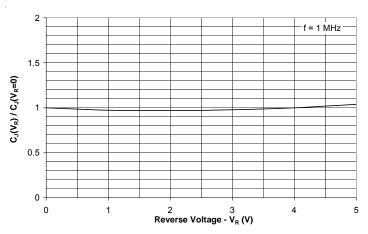
Power Derating Curve



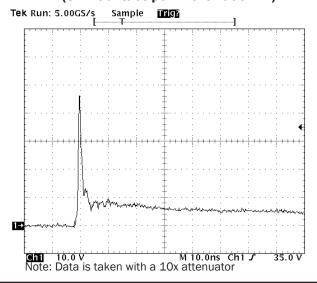
Clamping Voltage vs. Peak Pulse Current



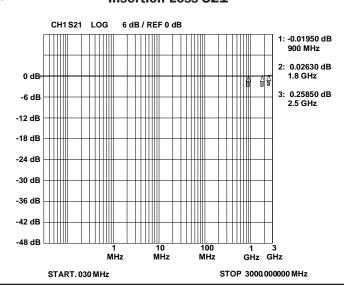
Normalized Capacitance vs. Reverse Voltage



ESD Clamping (8kV Contact per IEC 61000-4-2)



Insertion Loss S21





Applications Information

Device Connection Options

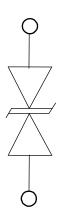
These low capacitance TVS diodes are designed to provide common mode protection for one high-speed line or differential protection for one line pair. The device is bidirectional and may be used on lines where the signal polarity is positive and negative.

Circuit Board Layout Recommendations for Suppression of ESD.

Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

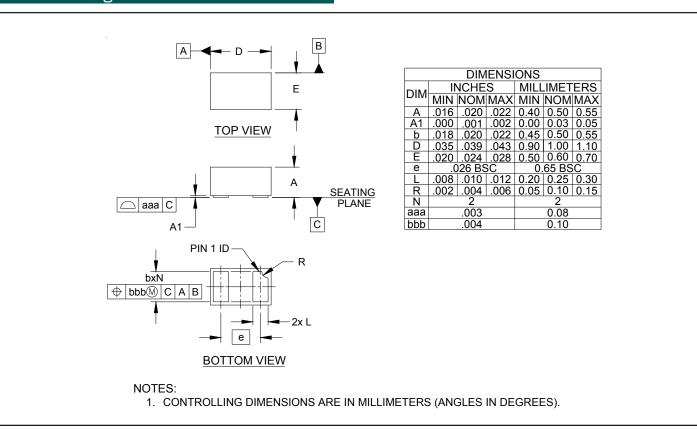
- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- Never run critical signals near board edges.
- Use ground planes whenever possible.

Equivalent Circuit Diagram

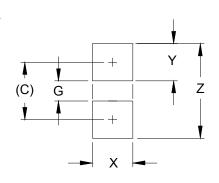




Outline Drawing - SLP1006P2



Land Pattern - SLP1006P2



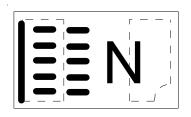
	DIMENSIONS						
DIM	INCHES	MILLIMETERS					
С	(.033)	(0.85)					
G	.012	0.30					
X	.024	0.60					
Y	.022	0.55					
Z	.055	1.40					

NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.



Marking Code



Ordering Information

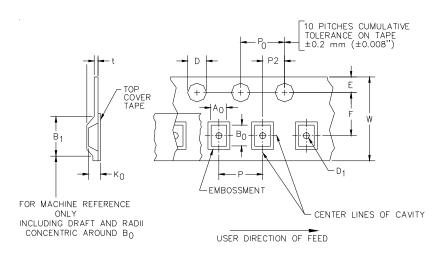
Part Number	Lead Finish	Qty per Reel	Reel Size	
RClamp0521PATCT	Pb Free	3,000	7 Inch	

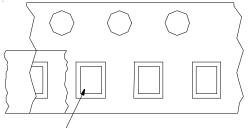
RailClamp and RClamp are marks of Semtech Corporation.

Notes:

- 1) Marking will also include line matrix date code
- 2) Device is electrically symmetrical

Tape and Reel Specification





Cathode Band/Date Code Location

User Direction of feed

Device Orientation in Tape

A0	ВО	КО		
0.69 +/-0.10 mm	1.19 +/-0.10 mm	0.66 +/-0.10 mm		

Tape Width	B, (Max)	D	D1	E	F	K (Max)	Р	PO	P2	T (Max)	W
8 mm	4.2 mm (.165)	1.5 + 0.1 mm - 0.0 mm (0.59 +.005 000)	0.8 mm ±0.25 (.031)	1.750±0.1 mm (.069±.004)	3.5±0.05 mm (.138±.002)	2.4 mm (.094)	4.0±0.10 mm (.157±.004)	4.0±0.1 mm (.157±.004)	2.0±0.05 mm (.079±.002)	0.4mm (.016)	8.0 mm + 0.3 mm - 0.1 mm (.312±.012)

Contact Information

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